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On April 1, 2005

PATENT
Attorney Docket No. 018865-004500US
Client Ref: 17732.1394



TOWNSEND and TOWNSEND and CREW LLP

By: MJD
Mark T. Davis

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Maria Cristina B. Estacio et al.

Patent No.: 6,870,254 B1

Filed: April 13, 2000

For: FLIP CLIP ATTACH AND
COPPER CLIP ATTACH ON MOSFET
DEVICE

Examiner: Nitin Parekh

Art Unit: 2811

**REQUEST FOR CERTIFICATE OF
CORRECTION**

Sir:

Pursuant to 37 CFR 1.322, Applicant submits a Request for Certificate of Correction correcting printing errors made at the time of printing of the patent. No fee is required for this Certificate. The desired corrections are set forth on form PTO 1050, enclosed.

Respectfully submitted,

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(Also Form PTO-1050)

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION**PATENT NO.** : **6,870,254 B1****DATED** : **March 22, 2005****INVENTOR(S)** : **Estacio et al.**

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

In claim 1, column 4, line 11, kindly delete “source and gate”

In claim 1, column 4, line 13, kindly delete “that the solder bumps” and insert --that the source and gate solder bumps--

In claim 1, column 4, line 25, kindly delete “apparatus”, and insert --apertures--

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PATENT NO. 6,870,254 B1